

产品规格承认书

SPECIFICATIONS

客户:

CUSTOMER: _____

产品名称: Bluetooth ANT

DESCRIPTION: 蓝牙天线

客户型号:

CUSTOMER PART No: _____

产品型号:

OUR MODEL NO: **PBX3216MP01**

日期:

DATE: 2020/12/22

确认签字, 盖章后请返回承认书一份


PLEASE RETURN TO US ONE COPY OF "SPECIFICATION FOR APPROVAL"
WITH YOUR APPROVED SIGNATURES

审核 Reviewed by	刘飞	制作 Prepared by	刘小美
-------------------	----	-------------------	-----

Manufacturer

Shenzhen pengban Xingye Technology Co., Ltd

Room 1016, Mintai Building, Minzhi Avenue, Minzhi Street, Longhua New District, Shenzhen

UNLESS OTHER SPECIFIED TOLERANCES ON: X=± X.X=± X.XX=		 深圳市朋伴兴业科技有限公司 Shenzhen pengban Xingye Technology Co., Ltd	
ANGLES = ± HOLEDIA = ±			
SCALE: N/A	UNIT: mm	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION	
DRAWN BY: Sera	CHECKED BY: XD		
DESIGNED BY: Sera	APPROVED BY: XD		
TITLE: CHIP2450-3216 Specification	DOCUMENT NO.	3216	SPEC REV. P1

PBX3216MP01 Specification

Operating Temp. : -40°C~+85°C

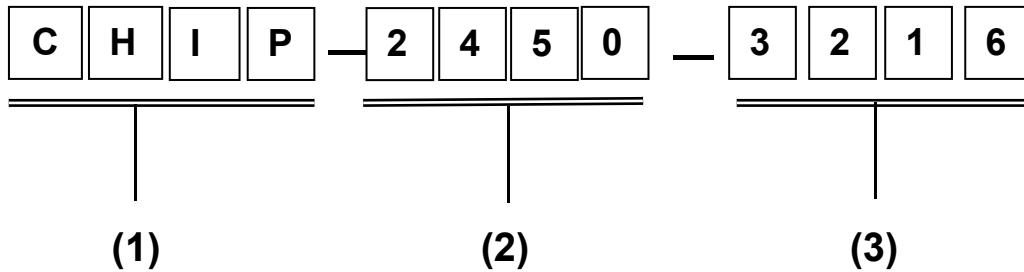
1. FEATURES:

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

2. APPLICATIONS:

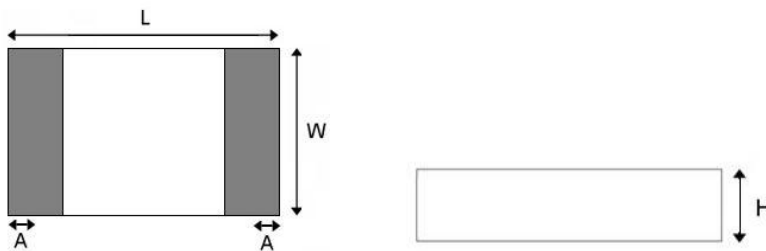
- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

3. PRODUCT IDENTIFICATION




- (1) Product type: Multilayer chip Antenna
 (2) Center Frequency: 2450MHz
 (3) External Dimensions (L×W) (mm): 3.2*1.6

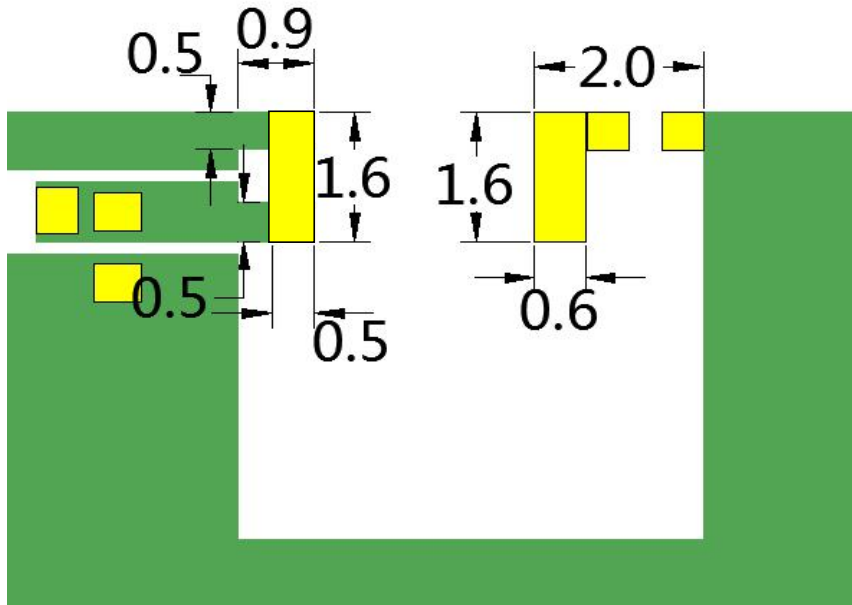
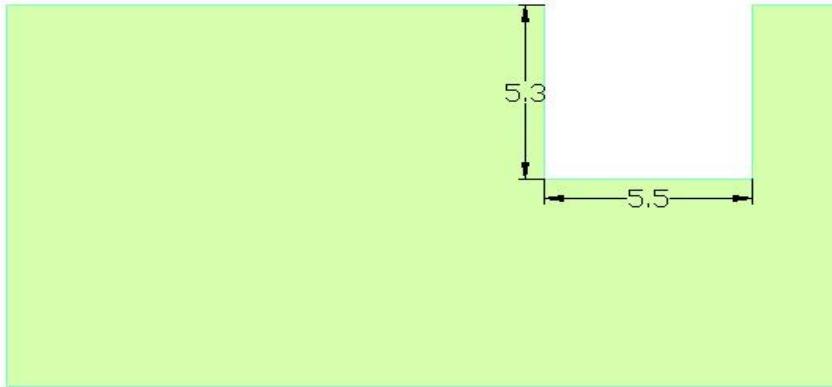
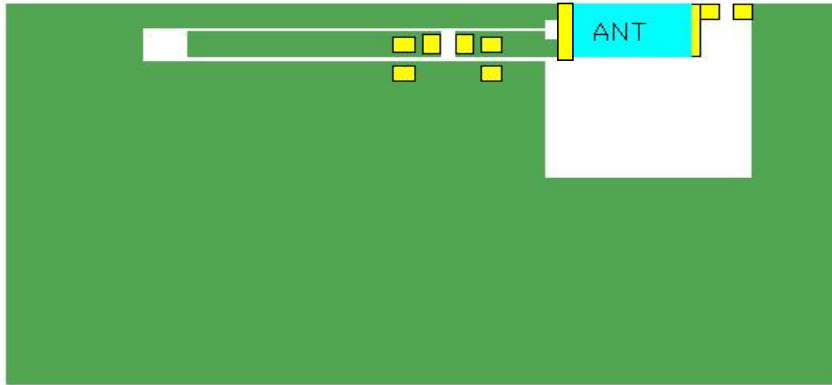
4. SHAPE AND DIMENSIONS:



L	W	H	A
3.2±0.2	1.6±0.2	0.52±0.1	0.4±0.1

UNLESS OTHER SPECIFIED TOLERANCES ON: X=± X.X=± X.XX= ANGLES = ± HOLEDIA = ±		 深圳市朋伴兴业科技有限公司 Shenzhen pengban Xingye Technology Co., Ltd		
SCALE: N/A	UNIT: mm	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION		
DRAWN BY : Sera	CHECKED BY: XD			
DESIGNED BY: Sera	APPROVED BY: XD			
TITLE: CHIP2450-3216 Specification		DOCUMENT NO.	3216	SPEC REV. P1

Size(mm):



UNLESS OTHER SPECIFIED TOLERANCES ON:

$X \pm$ $X.X \pm$ $X.XX =$
ANGLES = \pm **HOLEDIA** = \pm



深圳市朋伴兴业科技有限公司

Shenzhen pengban Xingye Technology Co., Ltd

SCALE: N/A

UNIT: mm

DRAWN BY : Sera

CHECKED BY: XD

DESIGNED BY: Sera

APPROVED BY: XD

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

TITLE: CHIP2450-3216 Specification

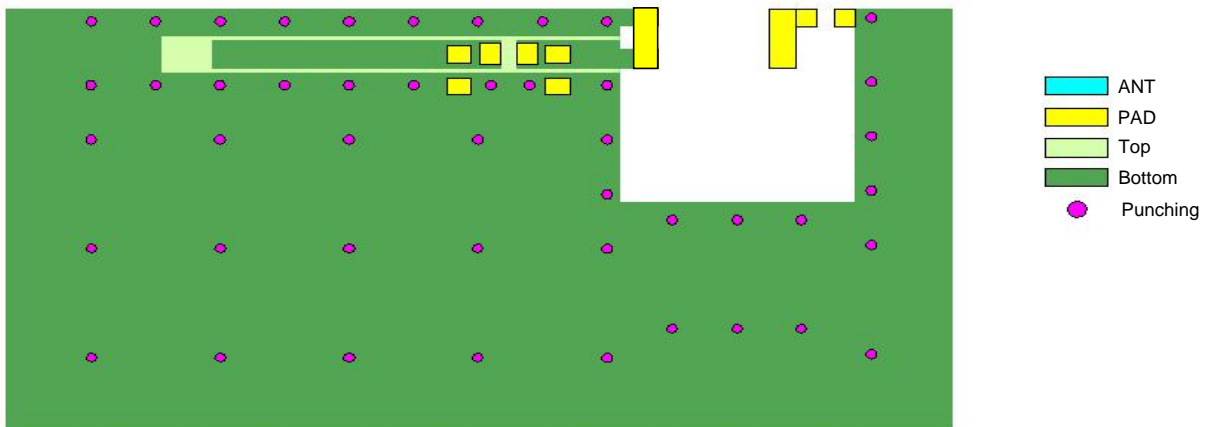
DOCUMENT NO.

3216

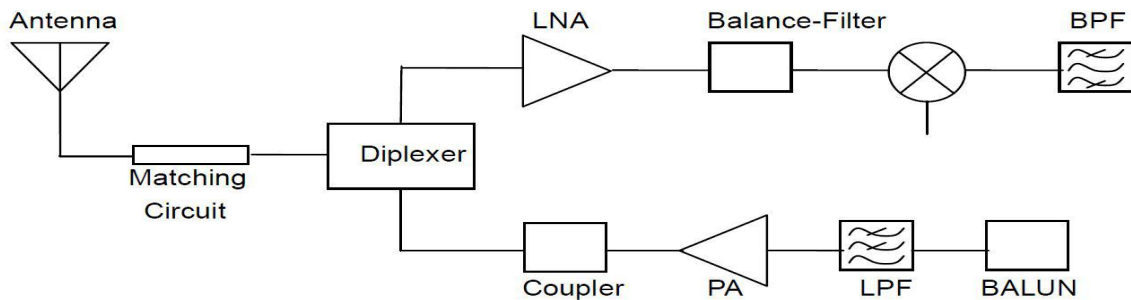
SPEC REV.

P1

Punching reference diagram




APPLICATION GUIDE



5. SPECIFICATIONS:

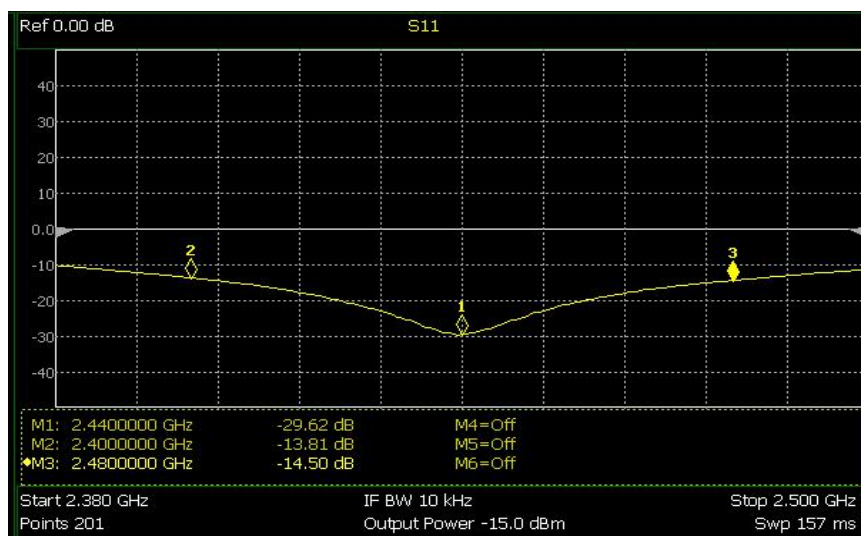
Test items	Specifications
bandwidth	2400-2483MHz
Maximum gain	2.67dbi
efficiency	72.3%
impedance	50Ω

* Test condition: Test board size 90*40 mm
 Matching circuit: Pi matching circuit will be required

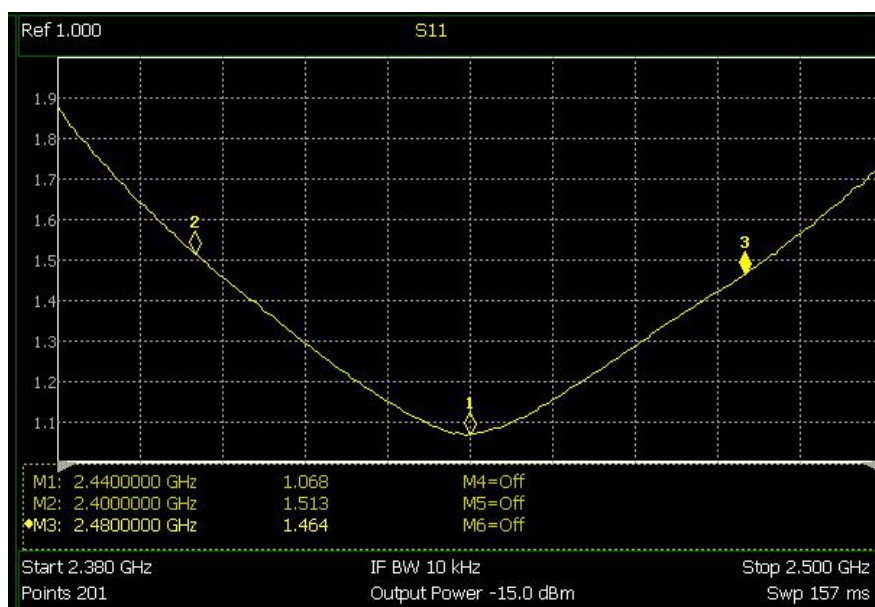
UNLESS OTHER SPECIFIED TOLERANCES ON: $X = \pm$ $X.X = \pm$ $X.XX =$ ANGLES = \pm HOLEDIA = \pm		 深圳市朋伴兴业科技有限公司 Shenzhen pengban Xingye Technology Co., Ltd		
SCALE: N/A	UNIT: mm	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION		
DRAWN BY : Sera	CHECKED BY: XD			
DESIGNED BY: Sera	APPROVED BY: XD			
TITLE: CHIP2450-3216 Specification		DOCUMENT NO.	3216	SPEC REV. P1

6. Electrical Characteristics :

Loss



VSWR



Mark	Frequency	VSWR
1	2400 MHz	1.513
2	2440 MHz	1.068
3	2480 MHz	1.464

UNLESS OTHER SPECIFIED TOLERANCES ON:

X=± X.X=± X.XX=

ANGLES = ± HOLEDIA = ±

SCALE: N/A

UNIT: mm

DRAWN BY : Sera

CHECKED BY: XD

DESIGNED BY: Sera

APPROVED BY: XD

TITLE: CHIP2450-3216 Specification



深圳市朋伴兴业科技有限公司

Shenzhen pengban Xingye Technology Co., Ltd

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

DOCUMENT NO.

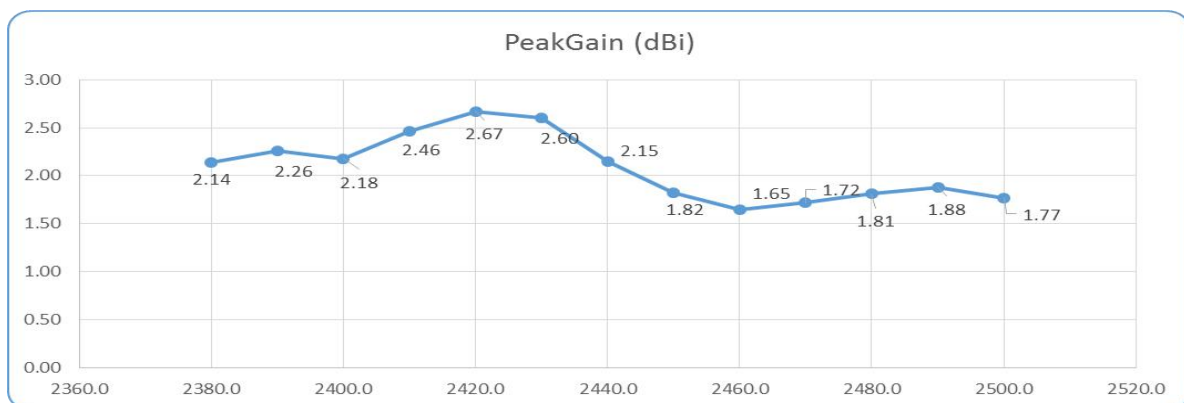
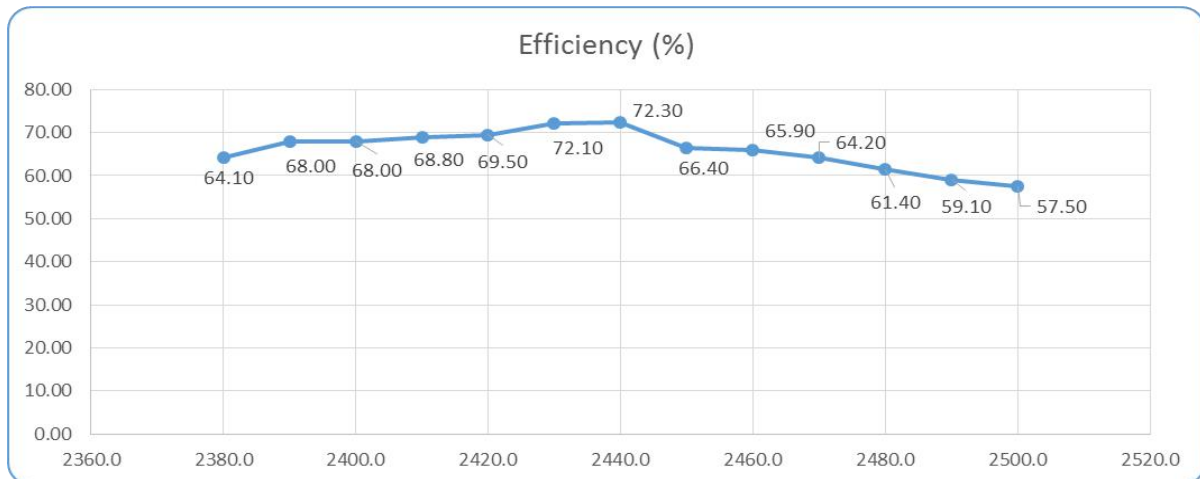
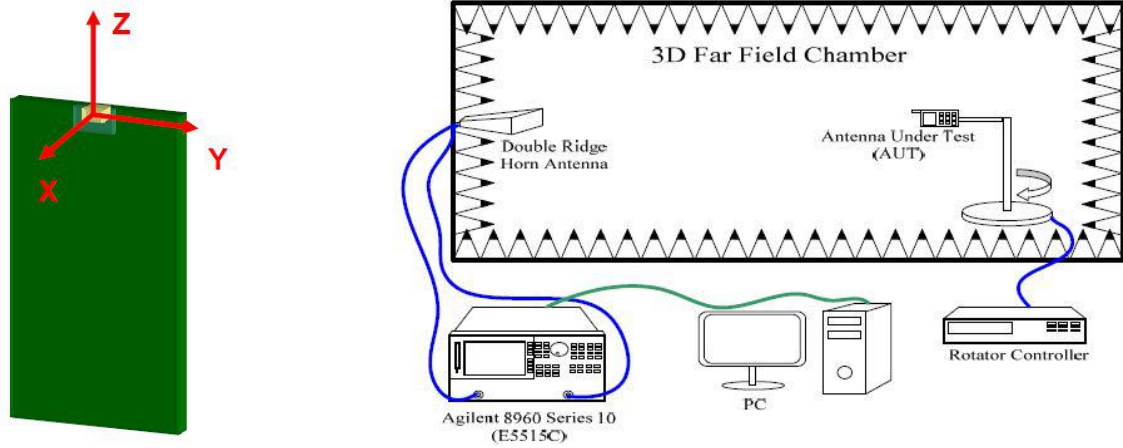
3216

SPEC REV.

P1

Radiation Pattern

The Gain pattern is measured in FAR-field chamber. DUT is placed on the table of rotator, a standard horn antenna and Vector Network Analyzer is used to collect data.



UNLESS OTHER SPECIFIED TOLERANCES ON:

X=± X.X=± X.XX=±
ANGLES = ± **HOLEDIA** = ±

SCALE: N/A	UNIT: mm
DRAWN BY: Sera	CHECKED BY: XD
DESIGNED BY: Sera	APPROVED BY: XD



深圳市朋伴兴业科技有限公司

Shenzhen pengban Xingye Technology Co., Ltd

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

TITLE: CHIP2450-3216 Specification

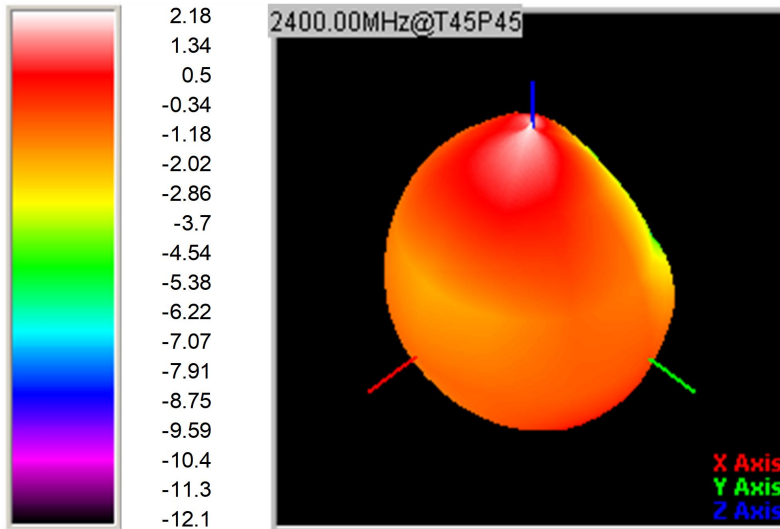
DOCUMENT NO.

3216

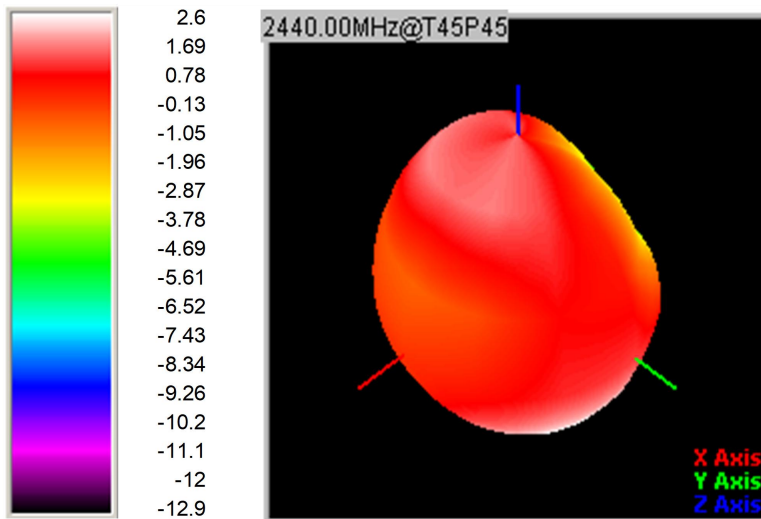
SPEC REV.

P1

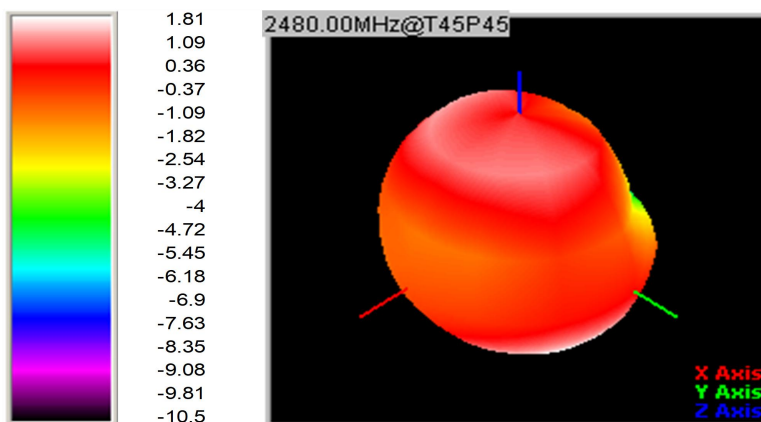
© 3D Gain Pattern (2400 MHz)



© 3D Gain Pattern (2440 MHz)



© 3D Gain Pattern (2480 MHz)



UNLESS OTHER SPECIFIED TOLERANCES ON:

X=± X.X=± X.XX=

ANGLES = ± HOLEDIA = ±



深圳市朋伴兴业科技有限公司

Shenzhen pengban Xingye Technology Co., Ltd

SCALE: N/A

UNIT: mm

DRAWN BY : Sera

CHECKED BY: XD

DESIGNED BY: Sera

APPROVED BY: XD

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

TITLE: CHIP2450-3216 Specification

DOCUMENT NO.

3216

SPEC REV.

P1

7. Environmental Characteristics

(1) Reliability Test

Item	Condition	Specification
Thermal shock	1. 30 ± 3 minutes at $-40^{\circ} \text{C} \pm 5^{\circ} \text{C}$, 2. Convert to $+105^{\circ} \text{C}$ (5 minutes) 3. 30 ± 3 minutes at $+105^{\circ} \text{C} \pm 5^{\circ} \text{C}$, 4. Convert to -40°C (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: $85 \pm 5^{\circ} \text{C}$ 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	1. Temperature: $150^{\circ} \text{C} \pm 5^{\circ} \text{C}$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Low temperature resistance	1. Temperature: $-40^{\circ} \text{C} \pm 5^{\circ} \text{C}$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	1. Solder bath temperature : $260 \pm 5^{\circ} \text{C}$ 2. Bathing time: 10 ± 1 seconds	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245 \pm 5^{\circ} \text{C}$ for 3 ± 1 seconds.	No apparent damage

(2) Storage Condition

(a) At warehouse:

The temperature should be within $0 \sim 30^{\circ} \text{C}$ and humidity should be less than 60% RH.

The product should be used within 1 year from the time of delivery.

(b) On board:

The temperature should be within $-40 \sim 85^{\circ} \text{C}$ and humidity should be less than 85% RH.

(3) Operating Temperature Range

Operating temperature range : -40°C to $+105^{\circ} \text{C}$.

UNLESS OTHER SPECIFIED TOLERANCES ON:

$X = \pm$ $X.X = \pm$ $X.XX =$
ANGLES = \pm **HOLEDIA** = \pm

SCALE: N/A

UNIT: mm

DRAWN BY : Sera

CHECKED BY: XD

DESIGNED BY: Sera

APPROVED BY: XD



深圳市朋伴兴业科技有限公司

Shenzhen pengban Xingye Technology Co., Ltd

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

TITLE: CHIP2450-3216 Specification

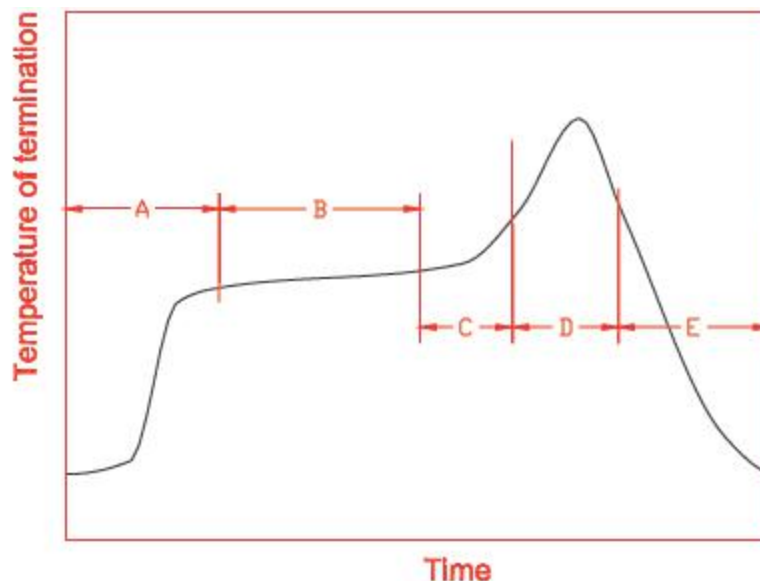
DOCUMENT NO.

3216

SPEC REV.

P1

8. Recommended Reflow Soldering



A	1 st rising temperature	The normal to Preheating temperature	30s to 60s
B	Preheating	140°C to 160°C	60s to 120s
C	2 nd rising temperature	Preheating to 200°C	20s to 40s
D	Main heating	if 220°C	50s~60s
		if 230°C	40s~50s
		if 240°C	30s~40s
		if 250°C	20s~40s
		if 260°C	20s~40s
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s

*reference: J-STD-020C


(1) Soldering Gun Procedure

Note the follows, in case of using solder gun for replacement.

- (a) The tip temperature must be less than 350° C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

(2) Soldering Volume

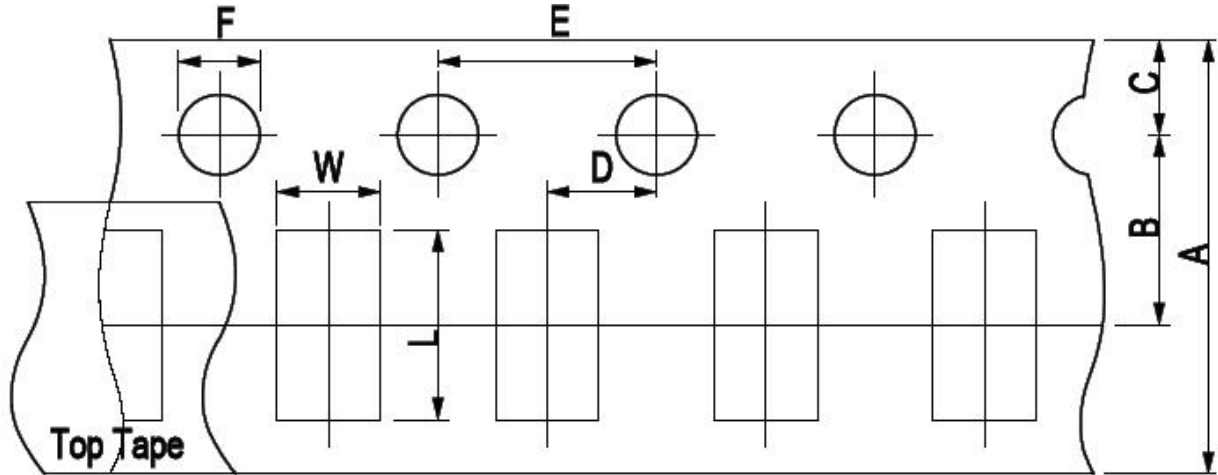
Note that excess of soldering volume will easily get crack the body of this product.

UNLESS OTHER SPECIFIED TOLERANCES ON: X=± X.X=± X.XX=		 深圳市朋伴兴业科技有限公司 Shenzhen pengban Xingye Technology Co., Ltd			
ANGLES = ± HOLEDIA = ±					
SCALE: N/A	UNIT: mm	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION			
DRAWN BY : Sera	CHECKED BY: XD				
DESIGNED BY: Sera	APPROVED BY: XD				
TITLE: CHIP2450-3216 Specification		DOCUMENT NO.	3216	SPEC REV.	P1

9. Taping Package and Label Marking: (unit: mm)

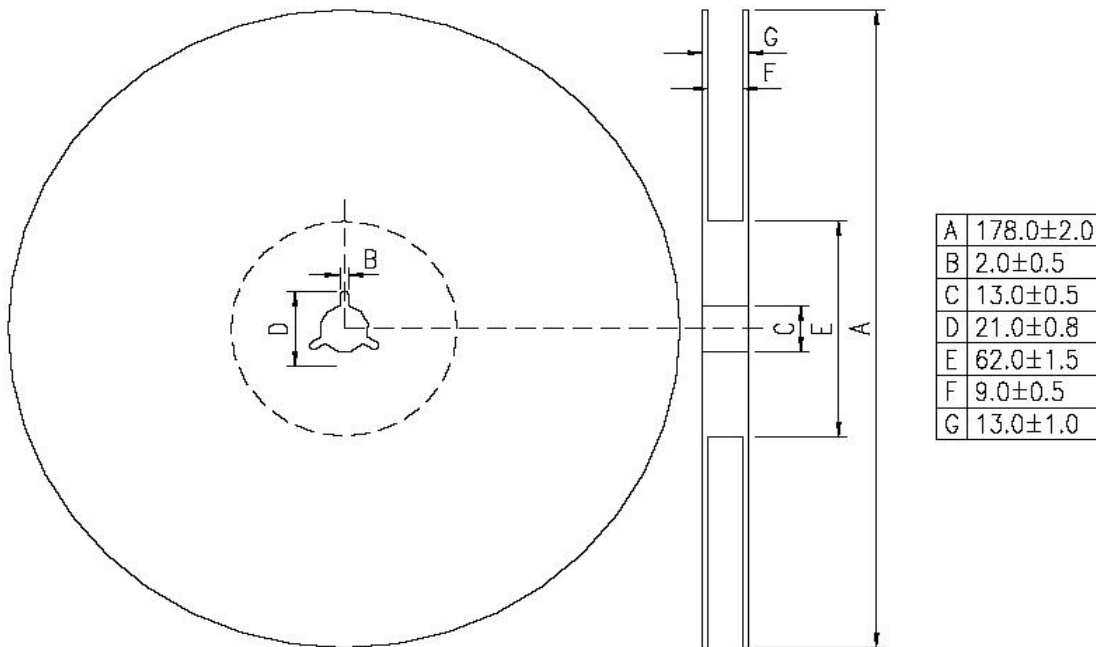
(1) Quantity/Reel: 5000pcs/Reel

(2) Carrier tape dimensions



Type	A	B	C	D	E	F	L	W
2450-21	8.00±0.3	3.50±0.05	1.75±0.1	2.00±0.05	4.00±0.1	1.50±0.1	2.30±0.1	1.55±0.1

(3) Taping reel dimensions



UNLESS OTHER SPECIFIED TOLERANCES ON:

X=± X.X=± X.XX=

ANGLES = ± HOLEDIA = ±



深圳市朋伴兴业科技有限公司

Shenzhen pengban Xingye Technology Co., Ltd

SCALE: N/A

UNIT: mm

DRAWN BY : Sera

CHECKED BY: XD

DESIGNED BY: Sera

APPROVED BY: XD

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

TITLE: CHIP2450-3216 Specification

DOCUMENT NO.

3216

SPEC REV.

P1